

10-25-2002

Form PTO-1595

(Rev. 03/01)

OMB No. 0651-0027 (exp. 5/31/2002)

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U.S. DEPARTMENT OF COMMERCE
U.S. Patent and Trademark OfficeU.S. PTO
29/169442
10/21/02

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

PARK, BOO YL

10/21/02

2. Name and address of receiving party(ies)

Name: DADA Corp.

Internal Address: 790-4 Yeoksam-Dong, Kangnam-Ku

DADA Bldg., Seoul, Republic of Korea

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:



Assignment



Merger



Security Agreement



Change of Name



Other

Street Address:

City: Seoul State: Zip: 135-080

Execution Date: 10/15/02

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

29169442

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Chulwoo Park

Internal Address: #575 West Madison St.

Apt#2512, Chicago, IL60661

Street Address:

City: Chicago State: IL Zip: 60661

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00



Enclosed



Authorized to be charged to deposit account

8. Deposit account number:

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9. Signature.

BOO YL PARK

Name of Person Signing

Signature

OCT. 15, 2002

Date

Total number of pages including cover sheet, attachments, and documents: 2

Mail documents to be recorded with required cover sheet information to:

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Washington, D.C. 20231

10/23/2002 MNEXONE4 00000111 29169442

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PATENT
REEL: 013409 FRAME: 0503

ASSIGNMENT OF APPLICATION

Docket Number (Optional)

Whereas, BOO YL PARK 56-3 Shin donga Apt. A-7 Yangjae-Dong
 of Seocho-Ku, Seoul, Republic of, hereafter
 referred to as applicant, have invented certain new and useful improvements in _____

☐ for which an application for a United States Patent was filed on _____
 Application Number _____/_____.

☐ for which an application for a United States Patent was executed on _____, and

Whereas, DADA Corp. of Republic of Korea herein referred
 to "assignee" whose mailing address is 790-4 Yeoksam-Dong, DADA Center Bldg., Kangnam-Ku, is
Seoul, Republic of Korea
 desirous of acquiring the entire right, title and interest in the same;

Now, therefore, in consideration of the sum of One dollars (\$ 1.00), the receipt whereof is acknowledged, and other good and valuable consideration, I/We, the applicant(s), by these presents do sell, assign and transfer unto said assignee the full and exclusive right to the said invention in the United States and the entire right, title and interest in and to any and all Patents which may be granted therefor in the United States, I/We hereby authorize and request the Commissioner of Patent and Trademarks to issue said United States Patent to said assignee, of the entire right, title, and interest in and to the same, for his sole use and behoof; and for the use and behoof of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

Executed this 15th day of October, 2002
 at the office of DADA Corp.

State of _____)

County of _____)

SS:

(Signature)

Before me personally appeared said _____

and acknowledged the foregoing instrument to be his free act and deed this _____

day of _____, 2002 _____.

Seal

(Notary Public)

Note: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required. See below*.

* ☐ Total of _____ forms are submitted.

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